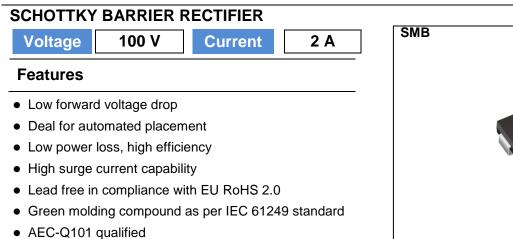
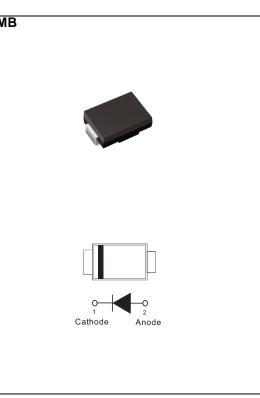
ΡΛΝ	ĴΪΤ
	SEMI CONDUCTOR

## S210L-AU



#### **Mechanical Data**

- Case: SMB Package
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx. Weight: 0.0032 ounces, 0.092 grams



### **Maximum Ratings and Thermal Characteristics** ( $T_A = 25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	LIMIT	UNITS
Maximum Repetitive Peak Reverse Voltage	V <sub>RRM</sub>	100	V
Maximum Rms Voltage	V <sub>RMS</sub>	70	V
Maximum Dc Blocking Voltage	V <sub>DC</sub>	100	V
Maximum Average Forward Current	I <sub>F(AV)</sub>	2	А
Peak Forward Surge Current: 8.3 ms Single Half Sine- Wave Superimposed On Rated Load	I <sub>FSM</sub>	50	А
Typical Junction Capacitance Measured at 1 MHZ And Applied $V_R = 4 V$	CJ	120	pF
Typical Thermal Resistance	${\sf R}_{ extsf{ heta}JA}^{(1)}$ ${\sf R}_{ extsf{ heta}JC}^{(2)}$	135 18	°C/W
Operating Junction Temperature Range	TJ	-55~150	°C
Storage Temperature Range	T <sub>STG</sub>	-55~150	°C





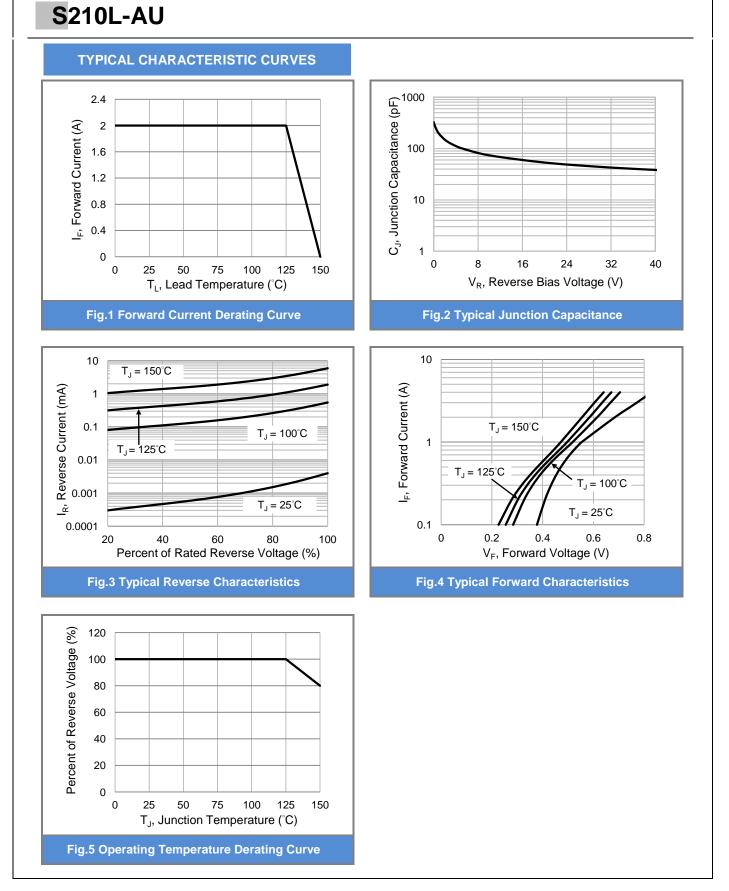
# S210L-AU

## **Electrical Characteristics** ( $T_A = 25^{\circ}C$ unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS
Forward Voltage	V <sub>F</sub>	$I_F = 0.5 \text{ A}, T_J = 25 \degree \text{C}$	-	0.47	-	V
		$I_F = 2.0 \text{ A}, \text{ T}_J = 25 ^{\circ}\text{C}$	-	-	0.74	
		I <sub>F</sub> = 0.5 A, T <sub>J</sub> = 125 °C	-	0.40	-	
		I <sub>F</sub> = 2.0 A, T <sub>J</sub> = 125 °C	-	0.59	-	
Reverse Current	$I_{R}^{(3)}$	$V_R = 80 \text{ V}, \text{ T}_J = 25 ^{\circ}\text{C}$	-	1.5	-	
		$V_R = 100 \text{ V}, \text{ T}_J = 25 ^{\circ}\text{C}$	-	-	150	uA
		$V_R = 100 \text{ V}, \text{ T}_J = 125 ^{\circ}\text{C}$	-	2	_	mA

NOTES:

- 1. Mounted on a FR4 PCB, single-sided copper, mini pad.
- 2. Mounted on a FR4 PCB, single-sided copper, with 100 cm<sup>2</sup> copper pad area
- 3. Short duration pulse test used to minimize self-heating effect.







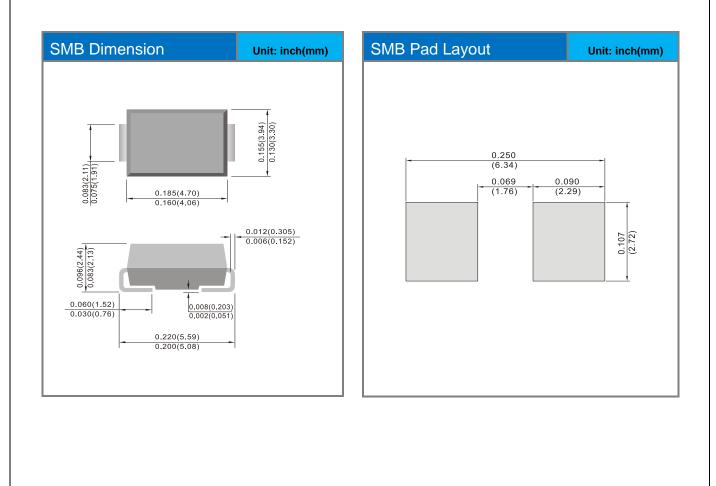


## S210L-AU

### Part No Packing Code Version

Part No Packing Code	Package Type	Packing Type	Marking	Version
S210L-AU_R2_000A1	SMB	3K pcs / 13" reel	S210L	Halogen free

### Packaging Information & Mounting Pad Layout





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